

YJ Planar Schottky Barrier Diode Die Specification

150V 3A, 55mil, Schottky barrier diode die based on silicon planar process
Part No.: PSB055H150SS-280A

Main Products Characterstics

- Average forward current: IF(AV) = 3 A
- Maximum operating junction temperature: Tj = 175 °C
- ESD rating: >2KV, per IEC61000-4-2 (Contact Discharge)
- Top metal: Ag

Maximum Ratings

Non-repetitive peak surge current (tp = 8.3 ms, halfwave, 1 cycle)	I _{FSM}	80 A
Storage temperature range	T _{stg}	-50 to +175 °C
Maximum operating junction temperature	T _j	175 °C

Static Electrical Characteristics (Ta = 25°C)

		Value	
		Spec	Typical
		155 V	170V
Maximum forward voltage drop I _F = 3 A	V _F	0.85V	0.79V
Pulse Test: tp = 300 μs, δ ≤ 2%			
		5uA	0.2uA

Device Schematics and Outline Drawing

Die Thickness *	11 Mils
Die Size **	
Top Metal Pad	50 Mils
Active Area	46 Mils
Top Metal	Ag
Back Metal	
Note: 1 * : Also can offer device with 8 mils thickness	
2 **: Cutting street width is around 1.5 mils	

Important Notice

Specification apply to die only. Actual performance may degrade when assembled.

does not guarantee device performance after assembly.

All operating parameters must be validated for each customer application by customer's technical experts.

Data sheet information is subjected to change without notice.

Recommended Storage Environment:

Store in original container, in dessicated nitrogen, with no contamination.

Shelf life for parts stored in above condition is 2 years.

If the storage is done in normal atmosphere shelf life is reduced to 6 months.